

## 74LCXZ16245

### Low Voltage 16-Bit Bidirectional Transceiver with 5V Tolerant Inputs and Outputs

#### General Description

The LCXZ16245 contains sixteen non-inverting bidirectional buffers with 3-STATE outputs and is intended for bus oriented applications. The device is designed for low voltage (2.7V or 3.3V)  $V_{CC}$  applications with capability of interfacing to a 5V signal environment. The device is byte controlled. Each byte has separate control inputs which could be shorted together for full 16-bit operation. The T/R inputs determine the direction of data flow through the device. The OE inputs disable both the A and B ports by placing them in a high impedance state.

When  $V_{CC}$  is between 0V and 1.5V, the LCXZ16245 is on the high impedance state during power-up or power-down. This places the outputs in the high impedance (Z) state preventing intermittent low impedance loading or glitching in bus oriented applications.

The LCXZ16245 is fabricated with an advanced CMOS technology to achieve high speed operation while maintaining CMOS low power dissipation.

#### Features

- 5V tolerant inputs and outputs
- 2.7V–3.6V  $V_{CC}$  specifications provided
- 4.5 ns  $t_{PD}$  max ( $V_{CC} = 3.3V$ ), 20  $\mu A$   $I_{CC}$  max
- Power-down high impedance inputs and outputs
- Supports live insertion/withdrawal (Note 1)
- $\pm 24$  mA output drive ( $V_{CC} = 3.0V$ )
- Implements patented noise/EMI reduction circuitry
- Latch-up performance conforms to the requirements of JESD78
- ESD performance:
  - Human body model > 2000V
  - Machine model > 200V

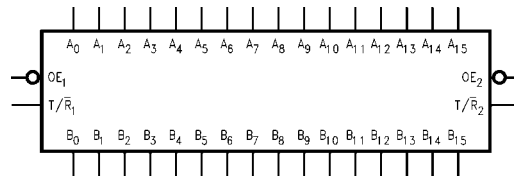
**Note 1:** To ensure the high-impedance state during power up or down, OE should be tied to  $V_{CC}$  through a pull-up resistor: the minimum value of the resistor is determined by the current-sourcing capability of the driver.

#### Ordering Code:

Order Number	Package Number	Package Description
74LCXZ16245MTD	MTD48	48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide

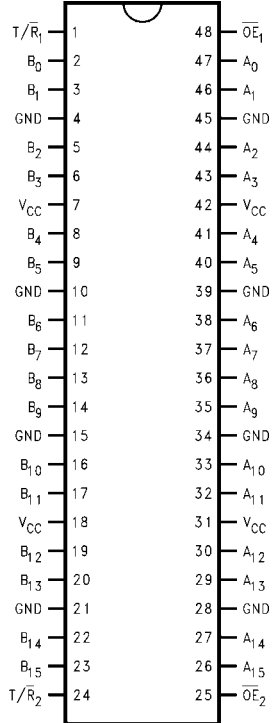
Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

#### Logic Symbol



### Connection Diagram

Pin Assignment for SSOP and TSSOP



### Pin Descriptions

Pin Names	Description
$\overline{OE}_n$	Output Enable Input
$T/\overline{R}_n$	Transmit/Receive Input
$A_0-A_{15}$	Side A Inputs or 3-STATE Outputs
$B_0-B_{15}$	Side B Inputs or 3-STATE Outputs
NC	No Connect

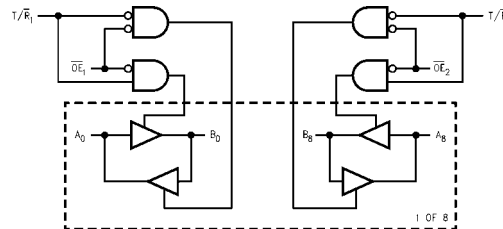
### Truth Tables

Inputs		Outputs
$\overline{OE}_1$	$T/\overline{R}_1$	
L	L	Bus $B_0-B_7$ Data to Bus $A_0-A_7$
L	H	Bus $A_0-A_7$ Data to Bus $B_0-B_7$
H	X	HIGH Z State on $A_0-A_7, B_0-B_7$

Inputs		Outputs
$\overline{OE}_2$	$T/\overline{R}_2$	
L	L	Bus $B_8-B_{15}$ Data to Bus $A_8-A_{15}$
L	H	Bus $A_8-A_{15}$ Data to Bus $B_8-B_{15}$
H	X	HIGH Z State on $A_8-A_{15}, B_8-B_{15}$

H = HIGH Voltage Level  
 L = LOW Voltage Level  
 X = Immaterial  
 Z = High Impedance

### Logic Diagram



Absolute Maximum Ratings <sup>(Note 2)</sup>						
Symbol	Parameter	Value	Conditions	Units		
V <sub>CC</sub>	Supply Voltage	-0.5 to +7.0		V		
V <sub>I</sub>	DC Input Voltage	-0.5 to +7.0		V		
V <sub>O</sub>	DC Output Voltage	-0.5 to +7.0	Output in 3-STATE	V		
		-0.5 to V <sub>CC</sub> + 0.5	Output in HIGH or LOW State (Note 3)			
I <sub>IK</sub>	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA		
I <sub>OK</sub>	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA		
		+50	V <sub>O</sub> > V <sub>CC</sub>			
I <sub>O</sub>	DC Output Source/Sink Current	±50		mA		
I <sub>CC</sub>	DC Supply Current per Supply Pin	±100		mA		
I <sub>GND</sub>	DC Ground Current per Ground Pin	±100		mA		
T <sub>STG</sub>	Storage Temperature	-65 to +150		°C		
Recommended Operating Conditions (Note 4)						
Symbol	Parameter	Min	Max	Units		
V <sub>CC</sub>	Supply Voltage	Operating	2.7	3.6	V	
V <sub>I</sub>	Input Voltage	0	5.5	V		
V <sub>O</sub>	Output Voltage	HIGH or LOW State	0	V <sub>CC</sub>	V	
		3-STATE	0	5.5		
I <sub>OH</sub> /I <sub>OL</sub>	Output Current	V <sub>CC</sub> = 3.0V - 3.6V		±24	mA	
		V <sub>CC</sub> = 2.7V - 3.0V		±12		
T <sub>A</sub>	Free-Air Operating Temperature	-40	85	°C		
Δt/ΔV	Input Edge Rate, V <sub>IN</sub> = 0.8V-2.0V, V <sub>CC</sub> = 3.0V	0	10	ns/V		
<p><b>Note 2:</b> The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.</p> <p><b>Note 3:</b> I<sub>O</sub> Absolute Maximum Rating must be observed.</p> <p><b>Note 4:</b> Unused inputs or I/O's must be held HIGH or LOW. They may not float.</p>						
DC Electrical Characteristics						
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> = -40°C to +85°C		Units
				Min	Max	
V <sub>IH</sub>	HIGH Level Input Voltage		2.7 - 3.6	2.0		V
V <sub>IL</sub>	LOW Level Input Voltage		2.7 - 3.6		0.8	V
V <sub>OH</sub>	HIGH Level Output Voltage	I <sub>OH</sub> = -100 μA	2.7 - 3.6	V <sub>CC</sub> - 0.2		V
		I <sub>OH</sub> = -12 mA	2.7	2.2		
		I <sub>OH</sub> = -18 mA	3.0	2.4		
		I <sub>OH</sub> = -24 mA	3.0	2.2		
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> = 100 μA	2.7 - 3.6		0.2	V
		I <sub>OL</sub> = 12 mA	2.7		0.4	
		I <sub>OL</sub> = 16 mA	3.0		0.4	
		I <sub>OL</sub> = 24 mA	3.0		0.55	
I <sub>I</sub>	Input Leakage Current	0 ≤ V <sub>I</sub> ≤ 5.5V	2.7 - 3.6		±5.0	μA
I <sub>OZ</sub>	3-STATE I/O Leakage	0 ≤ V <sub>O</sub> ≤ 5.5V V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	2.7 - 3.6		±5.0	μA
I <sub>OFF</sub>	Power-Off Leakage Current	V <sub>I</sub> or V <sub>O</sub> = 5.5V	0		10	μA
I <sub>PU/PD</sub>	Power-Up/Power-Down 3-STATE Output Current	V <sub>O</sub> = 0.5V to V <sub>CC</sub> V <sub>I</sub> = V <sub>CC</sub> or GND	0 - 1.5		±5.0	μA
I <sub>CC</sub>	Quiescent Supply Current	V <sub>I</sub> = V <sub>CC</sub> or GND	2.7-3.6		225	μA
		3.6V ≤ V <sub>I</sub> , V <sub>O</sub> ≤ 5.5V (Note 5)	2.7-3.6		±225	
ΔI <sub>CC</sub>	Increase in I <sub>CC</sub> per Input	V <sub>IH</sub> = V <sub>CC</sub> - 0.6V	2.7-3.6		500	μA
<p><b>Note 5:</b> Outputs disabled or 3-STATE only.</p>						

## AC Electrical Characteristics

Symbol	Parameter	$T_A = -40^\circ\text{C to } +85^\circ\text{C}, R_L = 500\Omega$				Units
		$V_{CC} = 3.3V \pm 0.3V$		$V_{CC} = 2.7V$		
		$C_L = 50\text{ pF}$		$C_L = 50\text{ pF}$		
		Min	Max	Min	Max	
$t_{PHL}$	Propagation Delay	1.0	4.5	1.0	5.2	ns
$t_{PLH}$	$A_n$ to $B_n$ or $B_n$ to $A_n$	1.0	4.5	1.0	5.2	
$t_{PZL}$	Output Enable Time	1.0	6.5	1.0	7.2	ns
$t_{PZH}$		1.0	6.5	1.0	7.2	
$t_{PLZ}$	Output Disable Time	1.0	6.4	1.0	6.9	ns
$t_{PHZ}$		1.0	6.4	1.0	6.9	
$t_{OSHL}$	Output to Output Skew (Note 6)		1.0			ns
$t_{OSLH}$			1.0			

**Note 6:** Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW ( $t_{OSHL}$ ) or LOW-to-HIGH ( $t_{OSLH}$ ). Parameter guaranteed by design.

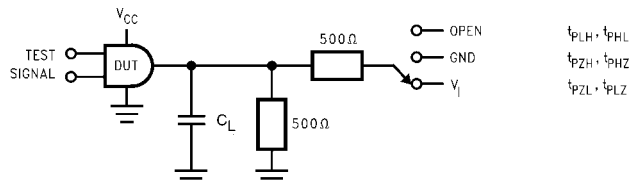
## Dynamic Switching Characteristics

Symbol	Parameter	Conditions	$V_{CC}$ (V)	$T_A = 25^\circ\text{C}$	Units
				Typical	
$V_{OLP}$	Quiet Output Dynamic Peak $V_{OL}$	$C_L = 50\text{ pF}, V_{IH} = 3.3V, V_{IL} = 0V$	3.3	0.8	V
$V_{OLV}$	Quiet Output Dynamic Valley $V_{OL}$	$C_L = 50\text{ pF}, V_{IH} = 3.3V, V_{IL} = 0V$	3.3	-0.8	V

## Capacitance

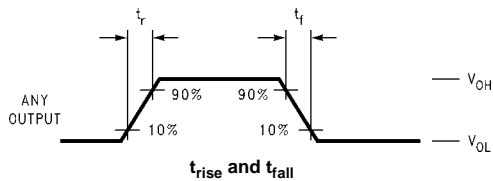
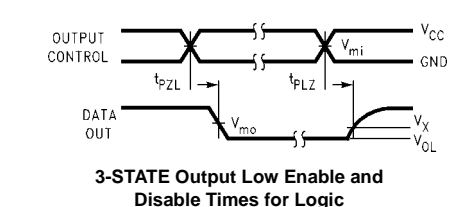
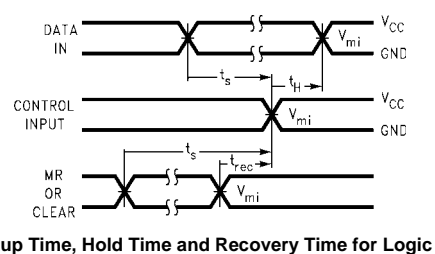
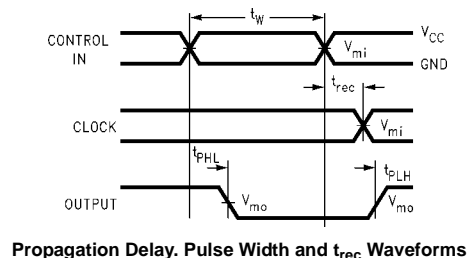
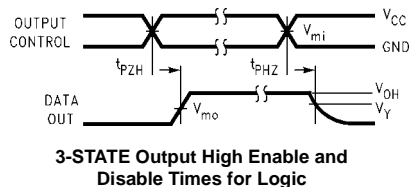
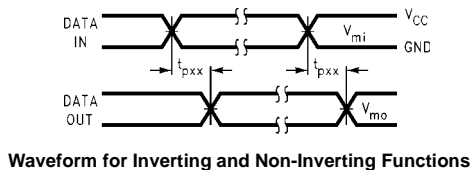
Symbol	Parameter	Conditions	Typical	Units
$C_{IN}$	Input Capacitance	$V_{CC} = \text{Open}, V_I = 0V \text{ or } V_{CC}$	7	pF
$C_{I/O}$	Input/Output Capacitance	$V_{CC} = 3.3V, V_I = 0V \text{ or } V_{CC}$	8	pF
$C_{PD}$	Power Dissipation Capacitance	$V_{CC} = 3.3V, V_I = 0V \text{ or } V_{CC}, f = 10\text{ MHz}$	20	pF

**AC LOADING and WAVEFORMS** Generic for LCX Family



**FIGURE 1. AC Test Circuit ( $C_L$  includes probe and jig capacitance)**

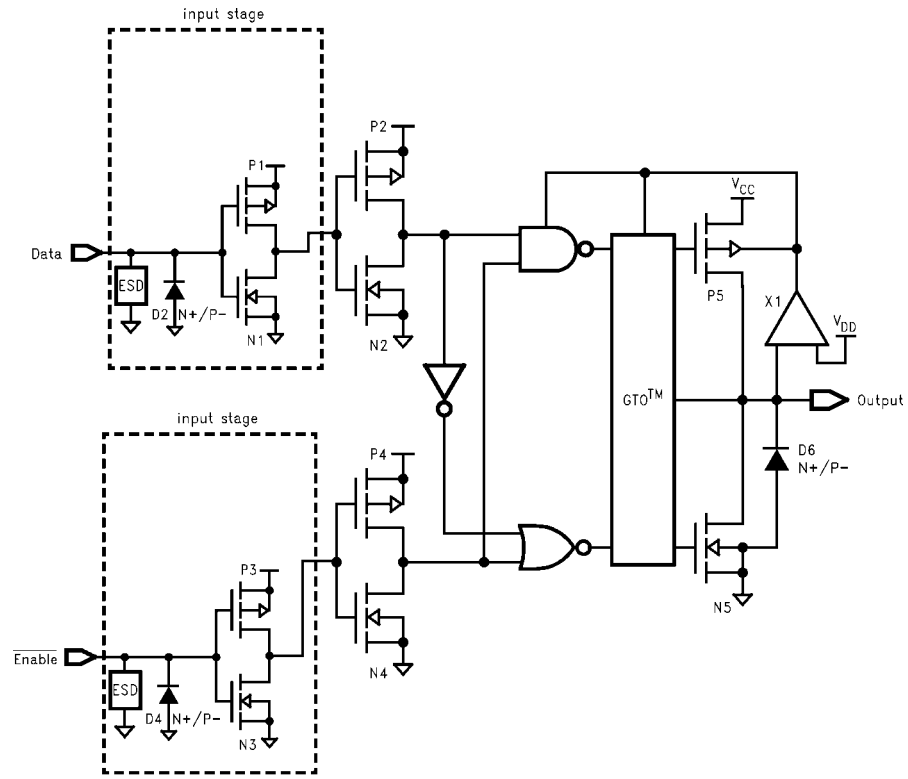
Test	Switch
$t_{PLH}, t_{PHL}$	Open
$t_{PZL}, t_{PLZ}$	6V at $V_{CC} = 3.3 \pm 0.3V$ , and 2.7V
$t_{PZH}, t_{PHZ}$	GND



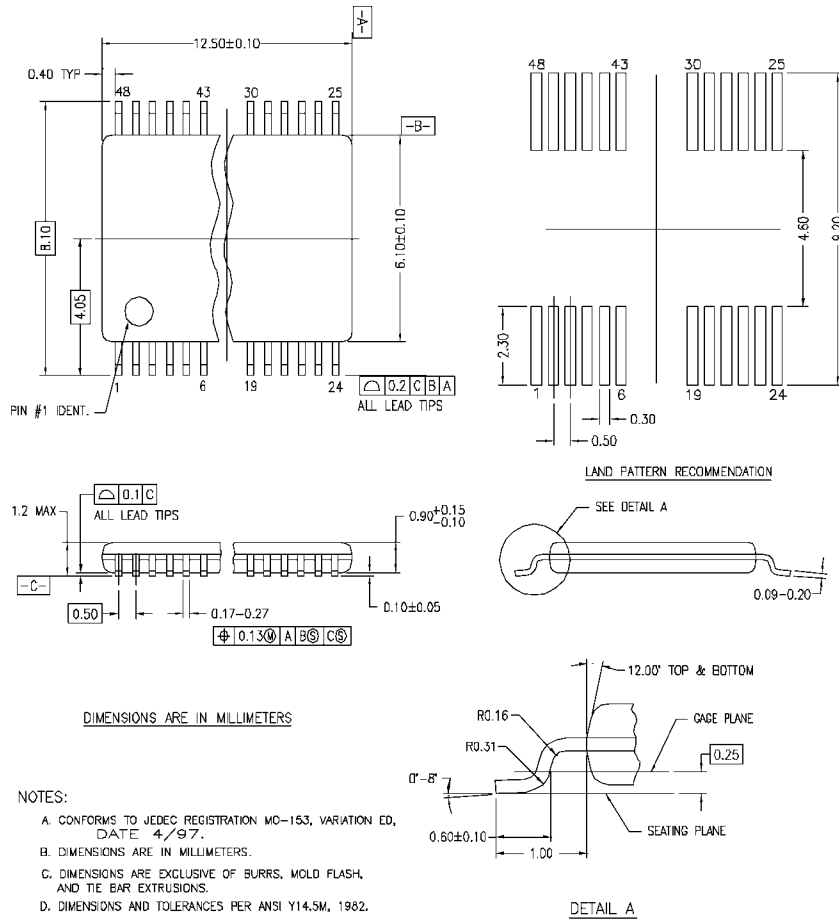
**FIGURE 2. Waveforms**  
(Input Characteristics;  $f = 1MHz$ ,  $t_r = t_f = 3ns$ )

Symbol	$V_{CC}$	
	3.3V $\pm$ 0.3V	2.7V
$V_{mi}$	1.5V	1.5V
$V_{mo}$	1.5V	1.5V
$V_x$	$V_{OL} + 0.3V$	$V_{OL} + 0.3V$
$V_y$	$V_{OH} - 0.3V$	$V_{OH} - 0.3V$

**Schematic Diagram** Generic for LCX Family



**Physical Dimensions** inches (millimeters) unless otherwise noted



MTD48REVC

**48-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 6.1mm Wide Package Number MTD48**

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